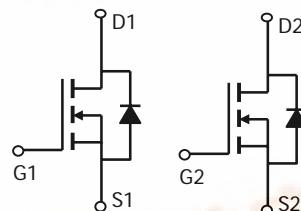
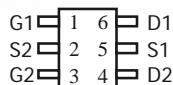


**AO6802****Dual N-Channel Enhancement Mode Field Effect Transistor****General Description**

The AO6802 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. Standard Product AO6802 is Pb-free (meets ROHS & Sony 259 specifications). AO6802L is a Green Product ordering option. AO6802 and AO6802L are electrically identical.

Features

V_{DS} (V) = 30V
 I_D = 3.1 A (V_{GS} = 10V)
 $R_{DS(ON)} < 75m\Omega$ (V_{GS} = 10V)
 $R_{DS(ON)} < 115m\Omega$ (V_{GS} = 4.5V)

TSOP6
Top View**Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted**

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^A $T_A=25^\circ C$	I_D	3.1	A
		2.4	
Pulsed Drain Current ^B	I_{DM}	12	
Power Dissipation ^A $T_A=25^\circ C$	P_D	1.15	W
		0.73	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics each FET

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A $t \leq 10s$	$R_{\theta JA}$	78	110	°C/W
		106	150	°C/W
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	64	80	°C/W

N-Channel Electrical Characteristics ($T_j=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=24\text{V}, V_{GS}=0\text{V}$ $T_j=55^\circ\text{C}$		1	5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm20\text{V}$			100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1	1.9	3	V
$I_{\text{D(ON)}}$	On state drain current	$V_{GS}=10\text{V}, V_{DS}=5\text{V}$	12			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=3.1\text{A}$ $T_j=125^\circ\text{C}$		54	75	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=2\text{A}$		78		
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=3.1\text{A}$		4.5		S
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}$		0.79	1	V
I_s	Maximum Body-Diode Continuous Current				2.5	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		200	240	pF
C_{oss}	Output Capacitance			40		pF
C_{rss}	Reverse Transfer Capacitance			20		pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		2.3	3	Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=3.1\text{A}$		6.5	8.5	nC
$Q_g(4.5\text{V})$	Total Gate Charge			3.1	4	nC
Q_{gs}	Gate Source Charge			1.2		nC
Q_{gd}	Gate Drain Charge			1.6		nC
$t_{\text{D(on)}}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=4.7\Omega, R_{\text{GEN}}=3\Omega$		3.3		ns
t_r	Turn-On Rise Time			2.5		ns
$t_{\text{D(off)}}$	Turn-Off Delay Time			13.2		ns
t_f	Turn-Off Fall Time			1.7		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=3.1\text{A}, dI/dt=100\text{A}/\mu\text{s}$		9.4	12	ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=3.1\text{A}, dI/dt=100\text{A}/\mu\text{s}$		3.5		nC

A: The value of R_{0JA} is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$.

The value in any given application depends on the user's specific board design. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R_{0JA} is the sum of the thermal impedance from junction to lead R_{0JL} and lead to ambient.

D. The static characteristics in Figures 1 to 6, 12, 14 are obtained using 80 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The SOA curve provides a single pulse rating.

Rev 1 : June 2005

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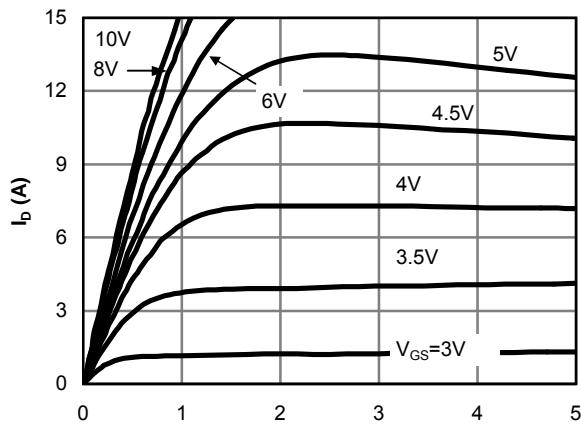
N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Fig 1: On-Region Characteristics

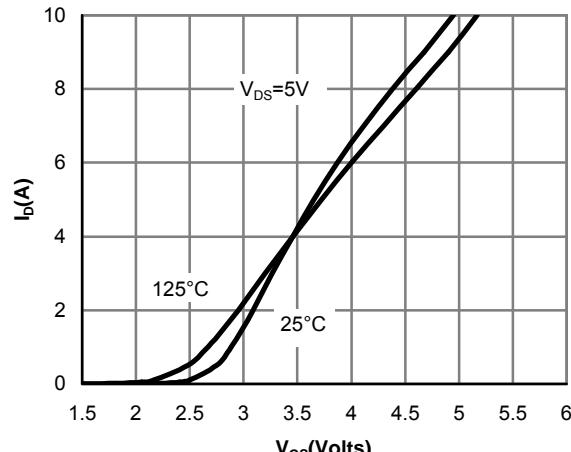


Figure 2: Transfer Characteristics

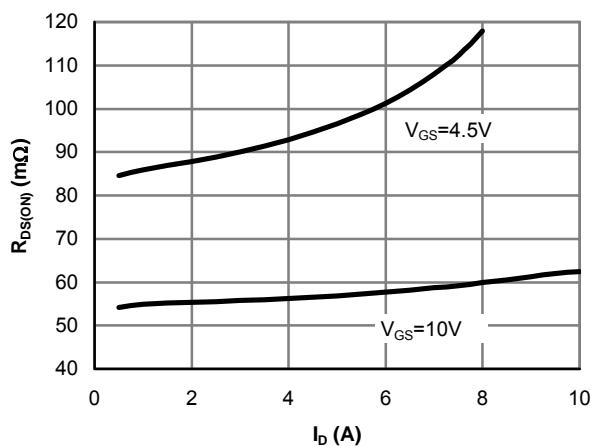


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

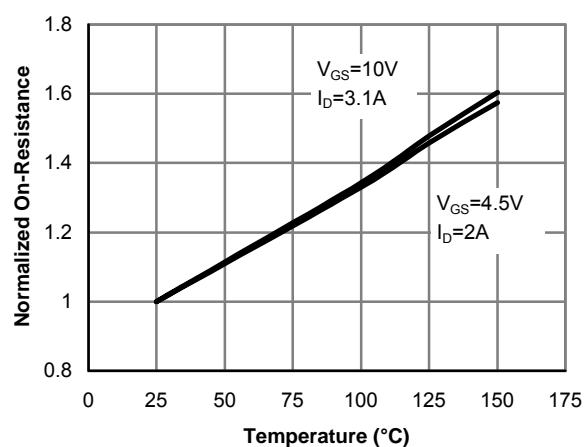


Figure 4: On-Resistance vs. Junction Temperature

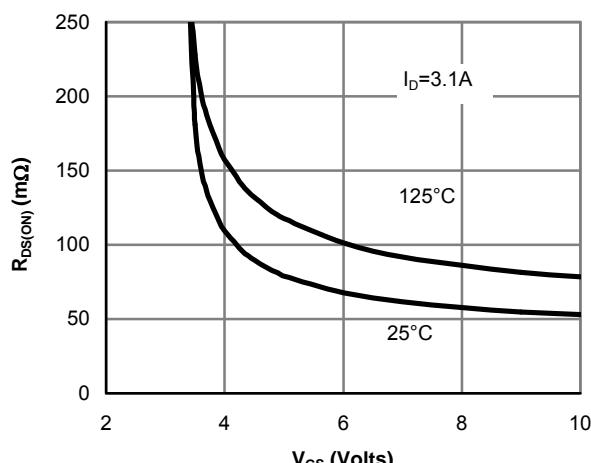


Figure 5: On-Resistance vs. Gate-Source Voltage

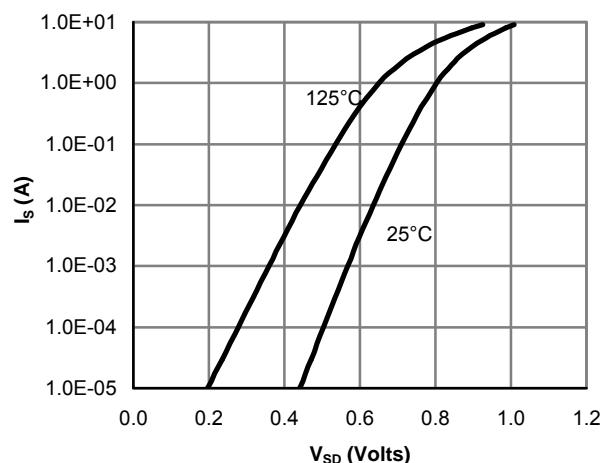


Figure 6: Body-Diode Characteristics

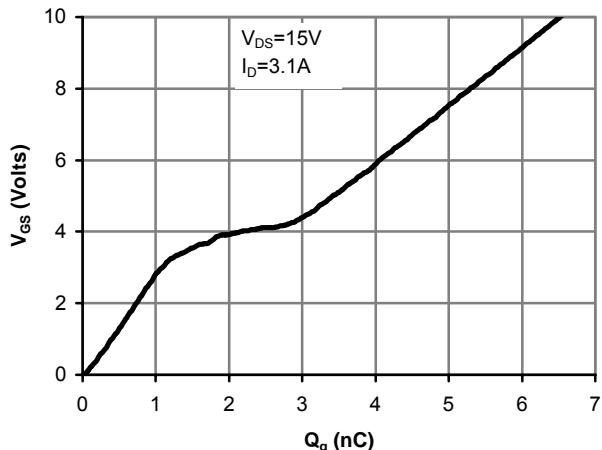
N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Figure 7: Gate-Charge Characteristics

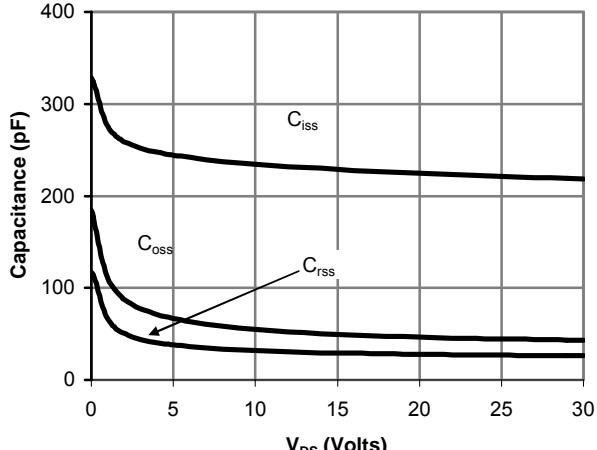


Figure 8: Capacitance Characteristics

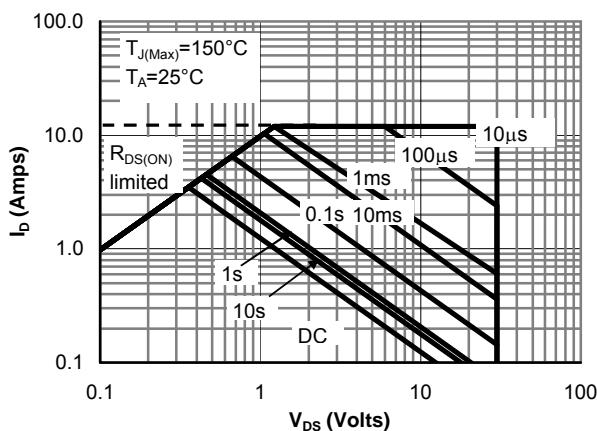


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

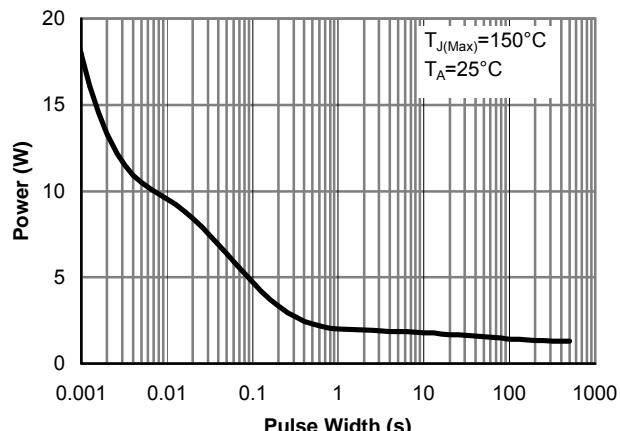


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

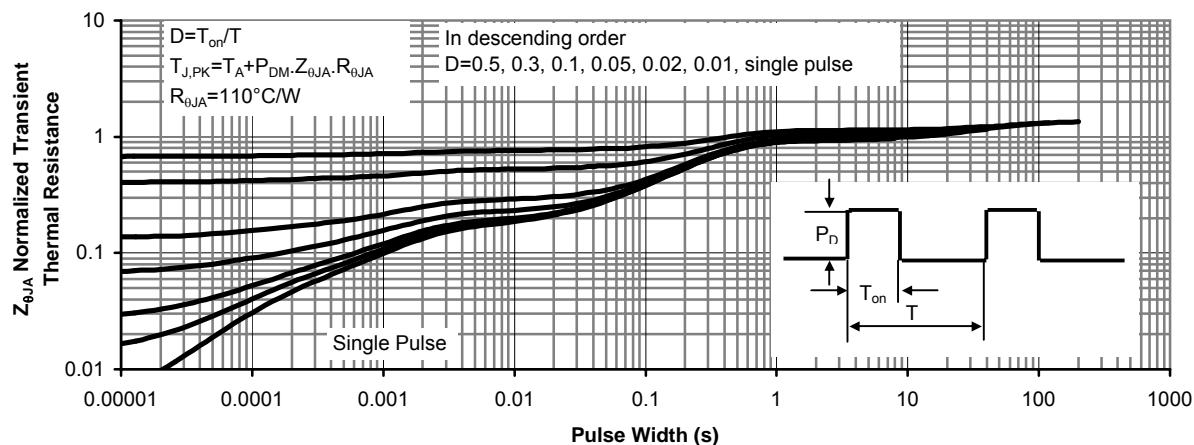


Figure 11: Normalized Maximum Transient Thermal Impedance